











**SN74AUP1G125** 





SCES595N - JULY 2004-REVISED JULY 2017

# SN74AUP1G125 Low-Power Single Bus Buffer Gate With 3-State Output

#### **Features**

- Available in the Texas Instruments NanoStar™
- Low Static-Power Consumption  $(I_{CC} = 0.9 \mu A Maximum)$
- Low Dynamic-Power Consumption  $(C_{pd} = 4 pF Typical at 3.3 V)$
- Low Input Capacitance ( $C_1 = 1.5 pF Typical$ )
- Low Noise Overshoot and Undershoot < 10% of  $V_{CC}$
- Input-Disable Feature Allows Floating Input Conditions
- Ioff Supports Partial-Power-Down Mode Operation
- Input Hysteresis Allows Slow Input Transition and Better Switching Noise Immunity at Input
- Wide Operating V<sub>CC</sub> Range of 0.8 V to 3.6 V
- 3.6-V I/O Tolerant to Support Mixed-Mode Signal Operation
- $t_{pd} = 4.6$  ns Maximum at 3.3 V

# **Applications**

- Audio Dock: Portable
- BluRay™ Players and Home Theaters
- Personal Digital Assistant (PDA)
- Power: Telecom/Server AC/DC Supply: Single Controller: Analog and Digital
- Solid-State Drive (SSD): Client and Enterprise
- TV: LCD/Digital and High-Definition (HDTV)
- Tablet: Enterprise
- Wireless Headsets, Keyboards, and Mice

## 3 Description

The SN74AUP1G125 bus buffer gate is a single line driver with a 3-state output. The output is disabled when the output-enable (OE) input is high. This device has the input-disable feature, which allows floating input signals.

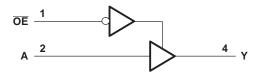
To ensure the high-impedance state during power up or power down, OE must be tied to V<sub>CC</sub> through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

#### Device Information<sup>(1)</sup>

| PART NUMBER     | PACKAGE    | BODY SIZE (NOM)   |  |  |
|-----------------|------------|-------------------|--|--|
| SN74AUP1G125DBV | SOT-23 (5) | 2.90 mm × 1.60 mm |  |  |
| SN74AUP1G125DCK | SC70 (5)   | 2.00 mm x 1.25 mm |  |  |
| SN74AUP1G125DRL | SOT (5)    | 1.60 mm x 1.20 mm |  |  |
| SN74AUP1G125DRY | CON (C)    | 1.45 mm × 1.00 mm |  |  |
| SN74AUP1G125DSF | SON (6)    | 1.00 mm × 1.00 mm |  |  |
| SN74AUP1G125YFP | DSBGA (6)  | 0.76 mm x 1.16 mm |  |  |
| SN74AUP1G125YZP | DSBGA (5)  | 0.89 mm × 1.39 mm |  |  |
| SN74AUP1G125YZT | DSBGA (5)  | 0.89 mm × 1.39 mm |  |  |
| SN74AUP1G125DPW | X2SON (5)  | 0.80 mm × 0.80 mm |  |  |

(1) For all available packages, see the orderable addendum at the end of the data sheet.

#### Simplified Schematic





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## 4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

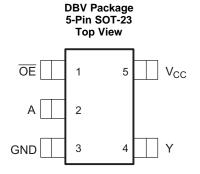
| ٠. | hanges from Revision M (December 2015) to Revision N   | Page |
|----|--|------|
| •  | Added DPW (X2SON) package  | 1    |
| •  | Deleted Device Comparison table, see Mechanical, Packaging, and Orderable Information section at the end of the data sheet                                     | 1    |
| •  | Changed Simplified Schematic with a new schematic  | 1    |
| •  | Added column for X2SON (DPW) package and separated columns for DSBGA packages in Pin Functions table   | 3    |
| •  | Changed values in the Thermal Information table to align with JEDEC standards  | 5    |
| •  | Added Balanced High-Drive CMOS Push-Pull Outputs, Standard CMOS Inputs, Clamp Diodes, Partial Power Down (I <sub>off</sub> ), and Over-voltage Tolerant Inputs | 15   |
| •  | Added Trace Example and revised Layout Guidelines  | 18   |
| •  | Added Receiving Notification of Documentation Updates section  | 20   |
|    |  |      |
| CI | hanges from Revision L (February 2013) to Revision M   | Page |

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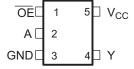
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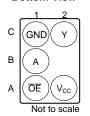
# 5 Pin Configuration and Functions



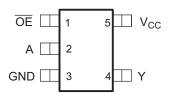
DRL Package 5-Pin SOT Top View



YZP or YZT Package 5-Pin DSBGA Bottom View



DCK Package 5-Pin SC70 Top View



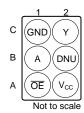
#### DSF Package 6-Pin SON Top View



DRY Package 6-Pin SON Top View



YFP Package 6-Pin DSBGA Bottom View



#### DPW Package 5-Pin X2SON Top View



#### **Pin Functions**

|                 |  | PIN                 |                       |                |     |                            |
|-----------------|--|---------------------|-----------------------|----------------|-----|----------------------------|
| NAME            | SOT-23 (DBV), SC70<br>(DCK), SOT (DRL),<br>X2SON (DPW) | SON (DRY<br>or DSF) | DSBGA (YZP<br>or YZT) | DSBGA<br>(YFP) | 1/0 | DESCRIPTION                |
| Α               | 2  | 2                   | B1                    | B1             | - 1 | Input                      |
| DNU             | _  | _                   | _                     | B2             | _   | Do not use                 |
| GND             | 3  | 3                   | C1                    | C1             | _   | Ground                     |
| N.C.            | _  | 5                   | _                     | _              | _   | No connection              |
| ŌĒ              | 1  | 1                   | A1                    | A1             | - 1 | Output enable (active low) |
| V <sub>CC</sub> | 5  | 6                   | A2                    | A2             | _   | Positive supply            |
| Υ               | 4  | 4                   | C2                    | C2             | 0   | Output                     |

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## **Specifications**

## 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)(1)

|                  |  |                    | MIN                   | MAX | UNIT |
|------------------|--|--------------------|-----------------------|-----|------|
| $V_{CC}$         | Supply voltage   |                    | -0.5                  | 4.6 | V    |
| $V_{I}$          | Input voltage <sup>(2)</sup>                                       | -0.5               | 4.6                   | V   |      |
| Vo               | Voltage applied to any output in the high-impedance or power-off s | -0.5               | 4.6                   | V   |      |
| Vo               | Output voltage in the high or low state <sup>(2)</sup>             | -0.5               | V <sub>CC</sub> + 0.5 | V   |      |
| I <sub>IK</sub>  | Input clamp current  | V <sub>1</sub> < 0 |                       | -50 | mA   |
| I <sub>OK</sub>  | Output clamp current   | V <sub>O</sub> < 0 |                       | -50 | mA   |
| Io               | Continuous output current  |                    |                       | ±20 | mA   |
|                  | Continuous current through V <sub>CC</sub> or GND                  |                    |                       | ±50 | mA   |
| $T_{J}$          | Junction temperature   |                    |                       | 150 | °C   |
| T <sub>stg</sub> | Storage temperature  |                    | -65                   | 150 | °C   |

Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating* Conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

## 6.2 ESD Ratings

|   |       |               |   | VALUE | UNIT |
|---|-------|---------------|---|-------|------|
| , | ,     | Electrostatic | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 (1)              | 2000  | \/   |
|   | (ESD) | discharge     | Charged-device model (CDM), per JEDEC specification JESD22-C101 (2) | 1000  | V    |

Product Folder Links: SN74AUP1G125

The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.



# 6.3 Recommended Operating Conditions

See (1)

|                 |                                    |  | MIN                    | MAX                    | UNIT |  |
|-----------------|------------------------------------|--|------------------------|------------------------|------|--|
| V <sub>CC</sub> | Supply voltage                     |  | 0.8                    | 3.6                    | V    |  |
|                 |                                    | V <sub>CC</sub> = 0.8 V                    | V <sub>CC</sub>        | 3.6                    |      |  |
| .,              | Himb lavel in a trade or           | V <sub>CC</sub> = 1.1 V to 1.95 V          | 0.65 × V <sub>CC</sub> | 3.6                    | .,   |  |
| $V_{IH}$        | High-level input voltage           | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | 1.6                    | 3.6                    | V    |  |
|                 |                                    | V <sub>CC</sub> = 3 V to 3.6 V             | 2                      | 3.6                    |      |  |
|                 |                                    | V <sub>CC</sub> = 0.8 V                    |                        | 0                      |      |  |
| V               | Low lovel input voltage            | V <sub>CC</sub> = 1.1 V to 1.95 V          | 0                      | 0.35 × V <sub>CC</sub> | V    |  |
| $V_{IL}$        | Low-level input voltage            | V <sub>CC</sub> = 2.3 V to 2.7 V           | 0                      | 0.7                    | V    |  |
|                 |                                    | V <sub>CC</sub> = 3 V to 3.6 V             | 0                      | 0.9                    |      |  |
| \ /             | Output walks as                    | Active state                               | 0                      | V <sub>CC</sub>        | V    |  |
| Vo              | Output voltage                     | 3-state                                    | 0                      | 3.6                    | V    |  |
|                 |                                    | V <sub>CC</sub> = 0.8 V                    |                        | -20                    | μA   |  |
|                 |                                    | V <sub>CC</sub> = 1.1 V                    |                        | -1.1                   |      |  |
|                 | Himb lavel autout august           | V <sub>CC</sub> = 1.4 V                    |                        | -1.7                   |      |  |
| I <sub>OH</sub> | High-level output current          | V <sub>CC</sub> = 1.65 V                   |                        | -1.9                   | mA   |  |
|                 |                                    | V <sub>CC</sub> = 2.3 V                    |                        | -3.1                   |      |  |
|                 |                                    | V <sub>CC</sub> = 3 V                      |                        | -4                     |      |  |
|                 |                                    | V <sub>CC</sub> = 0.8 V                    |                        | 20                     | μΑ   |  |
|                 |                                    | V <sub>CC</sub> = 1.1 V                    |                        | 1.1                    |      |  |
|                 | Laur laural autout ausmant         | V <sub>CC</sub> = 1.4 V                    |                        | 1.7                    |      |  |
| l <sub>OL</sub> | Low-level output current           | V <sub>CC</sub> = 1.65 V                   |                        | 1.9                    | mA   |  |
|                 |                                    | V <sub>CC</sub> = 2.3 V                    |                        | 3.1                    |      |  |
|                 |                                    | $V_{CC} = 3 \text{ V}$                     |                        | 4                      |      |  |
| Δt/Δν           | Input transition rise or fall rate | $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$ |                        | 200                    | ns/V |  |
| T <sub>A</sub>  | Operating free-air temperature     |  | -40                    | 85                     | °C   |  |

<sup>(1)</sup> All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. See the TI application report, *Implications of Slow of Floating CMOS Inputs*, SCBA004.

## 6.4 Thermal Information

| 0.4 1                 | nemiai imomia                                      |              |                 |              |              |              |                |                |                |      |
|-----------------------|--|--------------|-----------------|--------------|--------------|--------------|----------------|----------------|----------------|------|
|                       |  | SN74AUP1G125 |                 |              |              |              |                |                |                |      |
| THE                   | THERMAL METRIC <sup>(1)</sup>                      |              | DBV<br>(SOT-23) | DRL<br>(SOT) | DRY<br>(SON) | DSF<br>(SON) | YFP<br>(DSBGA) | YZP<br>(DSBGA) | DPW<br>(X2SON) | UNIT |
|                       |  |              | 5 PINS          | 5 PINS       | 6 PINS       | 6 PINS       | 6 PINS         | 5 PINS         | 5 PINS         |      |
| $R_{\theta JA}$       | Junction-to-<br>ambient thermal<br>resistance      | 303.6        | 230.5           | 295.1        | 342.1        | 377.1        | 125.4          | 146.2          | 504.3          | °C/W |
| $R_{\theta JC(top)}$  | Junction-to-case<br>(top) thermal<br>resistance    | 203.8        | 172.7           | 131.0        | 233.1        | 187.7        | 1.9            | 1.4            | 234.9          | °C/W |
| $R_{\theta JB}$       | Junction-to-board thermal resistance               | 100.9        | 62.2            | 143.9        | 206.7        | 236.6        | 37.2           | 39.3           | 370.3          | °C/W |
| ΨθJt                  | Junction-to-top<br>characterization<br>parameter   | 76.1         | 49.3            | 14.7         | 63.4         | 29.0         | 0.5            | 0.7            | 44.5           | °C/W |
| ΨθЈВ                  | Junction-to-board<br>characterization<br>parameter | 99.3         | 61.6            | 144.4        | 206.7        | 236.3        | 37.5           | 39.8           | 369.7          | °C/W |
| R <sub>0JC(bot)</sub> | Junction-to-case<br>(bottom) thermal<br>resistance | N/A          | N/A             | N/A          | N/A          | N/A          | N/A            | N/A            | 165.2          | °C/W |

<sup>(1)</sup> For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

Product Folder Links: SN74AUP1G125



# 6.5 Electrical Characteristics, T<sub>A</sub> = 25°C

|                      |                          | I <sub>OH</sub> = -20 μA  | 0.8 V to 3.6 V |                        |      |                       |     |  |
|----------------------|--------------------------|---|----------------|------------------------|------|-----------------------|-----|--|
|                      |                          |   | 3.0 V 10 0.0 V | $V_{CC} - 0.1$         |      |                       |     |  |
|                      |                          | $I_{OH} = -1.1 \text{ mA}$  | 1.1 V          | 0.75 × V <sub>CC</sub> |      |                       |     |  |
| V <sub>ОН</sub>      |                          | I <sub>OH</sub> = -1.7 mA   | 1.4 V          | 1.11                   |      |                       |     |  |
|                      |                          | I <sub>OH</sub> = -1.9 mA   | 1.65 V         | 1.32                   |      |                       | \ / |  |
|                      |                          | I <sub>OH</sub> = -2.3 mA   | 221/           | 2.05                   |      |                       | V   |  |
|                      |                          | I <sub>OH</sub> = -3.1 mA   | 2.3 V          | 1.9                    |      |                       |     |  |
|                      |                          | $I_{OH} = -2.7 \text{ mA}$  | 2.1/           | 2.72                   |      |                       |     |  |
|                      |                          | $I_{OH} = -4 \text{ mA}$  | 3 V            | 2.6                    |      |                       |     |  |
|                      |                          | I <sub>OL</sub> = 20 μA   | 0.8 V to 3.6 V |                        |      | 0.1                   |     |  |
|                      |                          | I <sub>OL</sub> = 1.1 mA  | 1.1 V          |                        |      | 0.3 × V <sub>CC</sub> |     |  |
|                      |                          | I <sub>OL</sub> = 1.7 mA  | 1.4 V          |                        |      | 0.31                  |     |  |
| $V_{OL}$             | I <sub>OL</sub> = 1.9 mA | 1.65 V  |                |                        | 0.31 | .,                    |     |  |
|                      | I <sub>OL</sub> = 2.3 mA | 0.01/   |                |                        | 0.31 | V                     |     |  |
|                      | I <sub>OL</sub> = 3.1 mA | 2.3 V   |                |                        | 0.44 |                       |     |  |
|                      |                          | I <sub>OL</sub> = 2.7 mA  | 0.1/           |                        |      | 0.31                  |     |  |
|                      |                          | I <sub>OL</sub> = 4 mA  | 3 V            |                        |      | 0.44                  |     |  |
|                      | A or OE input            | V <sub>I</sub> = GND to 3.6 V   | 0 V to 3.6 V   |                        |      | 0.1                   | μΑ  |  |
| l <sub>off</sub>     |                          | $V_I$ or $V_O = 0$ V to 3.6 V   | 0 V            |                        |      | 0.2                   | μΑ  |  |
| $\Delta I_{\rm off}$ |                          | $V_I$ or $V_O = 0 V$ to 3.6 V   | 0 V to 0.2 V   |                        |      | 0.2                   | μΑ  |  |
| l <sub>OZ</sub>      |                          | $V_O = V_{CC}$ or GND   | 3.6 V          |                        |      | 0.1                   | μΑ  |  |
| I <sub>CC</sub>      |                          | $\frac{V_L}{OE}$ = GND or (V <sub>CC</sub> to 3.6 V),<br>$\frac{V_C}{OE}$ = GND, I <sub>O</sub> = 0 | 0.8 V to 3.6 V |                        |      | 0.5                   | μΑ  |  |
|                      | A input                  | $V_{I} = V_{CC} - 0.6 V^{(1)},$   | 0.01/          |                        |      | 40                    |     |  |
| $\Delta I_{CC}$      | OE input                 | $I_0 = 0$   | 3.3 V          |                        | 110  | μΑ                    |     |  |
|                      | All inputs               | $\frac{V_I = GND \text{ to } 3.6 \text{ V},}{OE = V_{CC}^{(2)}}$                                    | 0.8 V to 3.6 V |                        |      |                       | μΛ  |  |
| 0                    |                          | V V as CND  | 0 V            |                        | 1.5  |                       |     |  |
| CI                   |                          | $V_I = V_{CC}$ or GND   | 3.6 V          |                        | 1.5  |                       | pF  |  |
| Co                   |                          | $V_O = V_{CC}$ or GND   | 3.6 V          |                        | 3    |                       | pF  |  |

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<sup>(1)</sup> One input at  $V_{CC}$  – 0.6 V, other input at  $V_{CC}$  or GND (2) To show  $I_{CC}$  is very low when the input-disable feature is enabled



# 6.6 Electrical Characteristics, $T_A = -40$ °C to +85°C

|                      | RAMETER       | TEST CONDITIONS   | V <sub>cc</sub> | MIN                   | TYP | MAX                 | UNIT |
|----------------------|---------------|---|-----------------|-----------------------|-----|---------------------|------|
|                      |               | I <sub>OH</sub> = -20 μA  | 0.8 V to 3.6 V  | V <sub>CC</sub> - 0.1 |     |                     |      |
|                      |               | I <sub>OH</sub> = -1.1 mA   | 1.1 V           | 0.7 × V <sub>CC</sub> |     |                     |      |
| V                    |               | I <sub>OH</sub> = -1.7 mA   | 1.4 V           | 1.03                  |     |                     |      |
|                      |               | I <sub>OH</sub> = -1.9 mA   | 1.65 V          | 1.3                   |     |                     | V    |
| V <sub>OH</sub>      |               | $I_{OH} = -2.3 \text{ mA}$  | 2.3 V           | 1.97                  |     |                     | V    |
|                      |               | $I_{OH} = -3.1 \text{ mA}$  | 2.5 V           | 1.85                  |     |                     |      |
|                      |               | $I_{OH} = -2.7 \text{ mA}$  | 3 V             | 2.67                  |     |                     |      |
|                      |               | $I_{OH} = -4 \text{ mA}$  | 3 V             | 2.55                  |     |                     |      |
|                      |               | $I_{OL} = 20 \mu A$   | 0.8 V to 3.6 V  |                       |     | 0.1                 |      |
|                      |               | I <sub>OL</sub> = 1.1 mA  | 1.1 V           |                       |     | $0.3 \times V_{CC}$ |      |
|                      |               | I <sub>OL</sub> = 1.7 mA  | 1.4 V           |                       |     | 0.37                |      |
| \/                   | $V_{OL}$      | I <sub>OL</sub> = 1.9 mA  | 1.65 V          |                       |     | 0.35                | V    |
| VOL                  |               | I <sub>OL</sub> = 2.3 mA  | 2.3 V           |                       |     | 0.33                | V    |
|                      |               | $I_{OL} = 3.1 \text{ mA}$   | 2.3 V           |                       |     | 0.45                |      |
|                      |               | $I_{OL} = 2.7 \text{ mA}$   | 3 V             |                       |     | 0.33                |      |
|                      |               | I <sub>OL</sub> = 4 mA  | 3 V             |                       |     | 0.45                |      |
| I <sub>I</sub>       | A or OE input | V <sub>I</sub> = GND to 3.6 V   | 0 V to 3.6 V    |                       |     | 0.5                 | μΑ   |
| I <sub>off</sub>     |               | $V_I$ or $V_O = 0 V$ to 3.6 V   | 0 V             |                       |     | 0.6                 | μΑ   |
| $\Delta I_{\rm off}$ |               | $V_I$ or $V_O = 0 V$ to 3.6 V   | 0 V to 0.2 V    |                       |     | 0.6                 | μΑ   |
| l <sub>OZ</sub>      |               | $V_O = V_{CC}$ or GND   | 3.6 V           |                       |     | 0.5                 | μΑ   |
| I <sub>CC</sub>      |               | $\frac{V_{I}}{OE}$ = GND or (V <sub>CC</sub> to 3.6 V),<br>$\frac{V_{I}}{OE}$ = GND, I <sub>O</sub> = 0 | 0.8 V to 3.6 V  |                       |     | 0.9                 | μΑ   |
|                      | A input       | $V_{I} = V_{CC} - 0.6 V^{(1)},$   | 221/            |                       |     | 50                  |      |
| $\Delta I_{CC}$      | OE input      | $I_{O} = 0$   | 3.3 V           |                       |     | 120                 | μΑ   |
| 4.00                 | All inputs    | $V_{\rm L}$ = GND to 3.6 V,<br>$\overline{\rm OE}$ = $V_{\rm CC}$ (2)                                   | 0.8 V to 3.6 V  |                       |     | 0                   | μ, , |

<sup>(1)</sup> One input at  $V_{CC}$  – 0.6 V, other input at  $V_{CC}$  or GND (2) To show  $I_{CC}$  is very low when the input-disable feature is enabled



# 6.7 Switching Characteristics, $C_L = 5 pF$

over recommended operating free-air temperature range,  $C_L = 5 \text{ pF}$  (unless otherwise noted) (see Figure 2 and Figure 3)

| PARAMETER       | FROM<br>(INPUT) | TO<br>(OUTPUT) | V <sub>cc</sub>                                  | T <sub>A</sub>                                      | MIN | TYP  | MAX  | UNIT |
|-----------------|-----------------|----------------|--|---|-----|------|------|------|
|                 |                 |                | 0.8 V  | T <sub>A</sub> = 25°C                               |     | 18.1 |      |      |
|                 |                 |                | 401/ 041/  | T <sub>A</sub> = 25°C                               | 4.3 | 7.4  | 12.6 |      |
|                 |                 |                | 1.2 V ± 0.1 V                                    | $T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ | 2.7 |      | 15.3 |      |
|                 |                 |                | 4.5.1/. 0.4.1/                                   | T <sub>A</sub> = 25°C                               | 3.3 | 5.2  | 8.5  |      |
|                 |                 |                | 1.5 V ± 0.1 V                                    | $T_A = -40$ °C to +85°C                             | 1   |      | 10.2 |      |
| t <sub>pd</sub> | Α               | Υ              | 4.0.1/ . 0.45.1/                                 | T <sub>A</sub> = 25°C                               | 2.6 | 4.1  | 6.8  | ns   |
|                 |                 |                | 1.8 V ± 0.15 V                                   | $T_A = -40$ °C to +85°C                             | 1.3 |      | 8.3  |      |
|                 |                 |                | 2.5 V ± 0.2 V                                    | T <sub>A</sub> = 25°C                               | 2   | 2.9  | 4.7  |      |
|                 |                 |                |  | $T_A = -40$ °C to +85°C                             | 1.1 |      | 5.8  |      |
|                 |                 |                | 3.3 V ± 0.3 V                                    | T <sub>A</sub> = 25°C                               | 1.7 | 2.4  | 3.8  |      |
|                 |                 |                | 3.3 V ± 0.3 V                                    | $T_A = -40$ °C to +85°C                             | 1   |      | 4.6  |      |
|                 |                 | Y              | 0.8 V  | T <sub>A</sub> = 25°C                               |     | 19.1 |      |      |
|                 |                 |                | 1.2 V ± 0.1 V                                    | T <sub>A</sub> = 25°C                               | 5.1 | 9.3  | 15.9 | ns   |
|                 |                 |                | 1.2 V ± 0.1 V                                    | $T_A = -40$ °C to +85°C                             | 3.6 |      | 19.2 |      |
|                 |                 |                | 1.5 V ± 0.1 V<br>1.8 V ± 0.15 V<br>2.5 V ± 0.2 V | T <sub>A</sub> = 25°C                               | 4.1 | 6.6  | 10.5 |      |
|                 | ŌĒ              |                |  | $T_A = -40$ °C to +85°C                             | 2.5 |      | 12.7 |      |
| en              |                 |                |  | T <sub>A</sub> = 25°C                               | 3.2 | 5.3  | 8.7  |      |
|                 |                 |                |  | $T_A = -40$ °C to +85°C                             | 2.1 |      | 10.3 |      |
|                 |                 |                |  | $T_A = 25^{\circ}C$                                 | 2.5 | 3.8  | 6    |      |
|                 |                 |                |  | $T_A = -40$ °C to +85°C                             | 1.6 |      | 7.2  |      |
|                 |                 |                | 3.3 V ± 0.3 V                                    | T <sub>A</sub> = 25°C                               | 2.1 | 3.2  | 4.9  |      |
|                 |                 |                | 0.5 V ± 0.5 V                                    | $T_A = -40$ °C to +85°C                             | 1.4 |      | 5.9  |      |
|                 |                 |                | 0.8 V  | $T_A = 25^{\circ}C$                                 |     | 12.1 |      |      |
|                 |                 |                | 1.2 V ± 0.1 V                                    | $T_A = 25^{\circ}C$                                 | 2.4 | 4.1  | 6.9  |      |
|                 |                 |                | 1.2 V ± 0.1 V                                    | $T_A = -40$ °C to +85°C                             | 2.2 |      | 7.7  |      |
|                 |                 |                | 1.5 V ± 0.1 V                                    | T <sub>A</sub> = 25°C                               | 1.8 | 2.9  | 4.5  |      |
|                 |                 |                | 1.5 V ± 0.1 V                                    | $T_A = -40$ °C to +85°C                             | 1.7 |      | 5.1  |      |
| dis             | ŌE              | Y              | 1.8 V ± 0.15 V                                   | $T_A = 25^{\circ}C$                                 | 1   | 2.9  | 4.3  | ns   |
|                 |                 |                | 1.0 V ± 0.13 V                                   | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$       | 1.5 |      | 4.7  |      |
|                 |                 | 2.5 V ± 0.2 V  | T <sub>A</sub> = 25°C                            | 1   | 1.8 | 2.7  |      |      |
|                 |                 |                | 2.5 V ± 0.2 V                                    | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$       | 1   |      | 3.3  |      |
|                 |                 |                | 221/.021/  | T <sub>A</sub> = 25°C                               | 1.2 | 2.2  | 3.2  |      |
|                 |                 | 3.3 V ± 0.3 V  | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$    | 1.1   |     | 4    |      |      |

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# 6.8 Switching Characteristics, $C_L = 10 pF$

over recommended operating free-air temperature range,  $C_L = 10 \text{ pF}$  (unless otherwise noted) (see Figure 2 and Figure 3)

| PARAMETER       | FROM<br>(INPUT) | TO<br>(OUTPUT) | V <sub>cc</sub>                                     | T <sub>A</sub>                                | MIN | TYP  | MAX  | UNIT |
|-----------------|-----------------|----------------|---|---|-----|------|------|------|
|                 |                 |                | 0.8 V   | T <sub>A</sub> = 25°C                         |     | 20.5 |      |      |
|                 |                 |                | 427/.047/   | T <sub>A</sub> = 25°C                         | 4.6 | 8.4  | 13.7 |      |
|                 |                 |                | 1.2 V ± 0.1 V                                       | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 3.6 |      | 16.6 |      |
|                 |                 |                | 451/ 041/   | T <sub>A</sub> = 25°C                         | 3.5 | 5.9  | 9.3  |      |
|                 |                 | Y              | 1.5 V ± 0.1 V                                       | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 2.4 |      | 11.1 |      |
| t <sub>pd</sub> | A or B          |                | 1.8 V ± 0.15 V                                      | T <sub>A</sub> = 25°C                         | 3.9 | 4.7  | 7.5  | ns   |
|                 |                 |                |   | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 1.3 |      | 9.1  |      |
|                 |                 |                | 2.5 V ± 0.2 V                                       | T <sub>A</sub> = 25°C                         | 2.3 | 3.4  | 5.3  |      |
|                 |                 |                |   | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 1.6 |      | 6.4  |      |
|                 |                 |                | 3.3 V ± 0.3 V                                       | T <sub>A</sub> = 25°C                         | 2.1 | 2.8  | 4.3  |      |
|                 |                 |                |   | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 1.4 |      | 5.2  |      |
|                 |                 |                | 0.8 V   | T <sub>A</sub> = 25°C                         |     | 21.8 |      |      |
|                 |                 | Y              | 1.2 V ± 0.1 V                                       | T <sub>A</sub> = 25°C                         | 4.9 | 10.2 | 16.8 | ns   |
|                 |                 |                | 1.2 V ± 0.1 V                                       | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 4.4 |      | 20.2 |      |
|                 |                 |                | 1.5 V ± 0.1 V                                       | T <sub>A</sub> = 25°C                         | 3.9 | 7.3  | 11.2 |      |
|                 | ŌĒ              |                |   | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 3.3 |      | 13.5 |      |
| en              |                 |                | 1.8 V ± 0.15 V                                      | T <sub>A</sub> = 25°C                         | 3.4 | 5.8  | 9.2  |      |
|                 |                 |                |   | $T_A = -40$ °C to +85°C                       | 2.7 |      | 11   |      |
|                 |                 |                | 2.5 V ± 0.2 V                                       | T <sub>A</sub> = 25°C                         | 2.5 | 4.3  | 6.4  |      |
|                 |                 |                |   | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 2.1 |      | 7.8  |      |
|                 |                 |                | 0.01/ 0.01/   | T <sub>A</sub> = 25°C                         | 2.1 | 3.7  | 5.4  |      |
|                 |                 |                | 3.3 V ± 0.3 V                                       | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 1.9 |      | 6.4  |      |
|                 |                 |                | 0.8 V   | T <sub>A</sub> = 25°C                         |     | 13   |      |      |
|                 |                 |                | 427/.047/   | T <sub>A</sub> = 25°C                         | 3.8 | 6.6  | 11.7 |      |
|                 |                 |                | 1.2 V ± 0.1 V                                       | $T_A = -40$ °C to +85°C                       | 1.2 |      | 14   |      |
|                 |                 |                | 4511.0411   | T <sub>A</sub> = 25°C                         | 2.2 | 4.7  | 7.9  |      |
|                 |                 |                | 1.5 V ± 0.1 V                                       | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 1.3 |      | 9.3  |      |
| dis             | ŌĒ              | Υ              | 4.0.1/ . 0.45.1/                                    | T <sub>A</sub> = 25°C                         | 2.4 | 4.4  | 6.4  | ns   |
|                 |                 |                | 1.8 V ± 0.15 V                                      | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 2.2 |      | 7.5  |      |
|                 |                 |                | 251.001   | T <sub>A</sub> = 25°C                         | 1.3 | 3.1  | 4.9  |      |
|                 |                 |                | 2.5 V ± 0.2 V                                       | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 1.2 |      | 5.4  |      |
|                 |                 |                | 0.01/ 0.01/   | T <sub>A</sub> = 25°C                         | 1.9 | 3.4  | 5    |      |
|                 |                 | 3.3 V ± 0.3 V  | $T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ | 1.9   |     | 5.6  |      |      |

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# 6.9 Switching Characteristics, $C_L = 15 pF$

over recommended operating free-air temperature range,  $C_L = 15 \text{ pF}$  (unless otherwise noted) (see Figure 2 and Figure 3)

| PARAMETER | FROM<br>(INPUT) | TO<br>(OUTPUT) | v <sub>cc</sub>  | T <sub>A</sub>                                      | MIN | TYP  | MAX  | UNIT |  |
|-----------|-----------------|----------------|------------------|---|-----|------|------|------|--|
|           |                 |                | 0.8 V            | $T_A = 25^{\circ}C$                                 |     | 22.5 |      |      |  |
|           |                 |                | 121/.011/        | $T_A = 25^{\circ}C$                                 | 5.8 | 9.3  | 15.1 |      |  |
|           |                 |                | 1.2 V ± 0.1 V    | $T_A = -40$ °C to +85°C                             | 4.3 |      | 17.9 |      |  |
|           |                 |                | 4511.0411        | T <sub>A</sub> = 25°C                               | 4.4 | 6.6  | 10.2 |      |  |
|           | A or B          |                | 1.5 V ± 0.1 V    | $T_A = -40$ °C to +85°C                             | 3   |      | 12.1 |      |  |
| pd        |                 | Υ              | 1.8 V ± 0.15 V   | $T_A = 25^{\circ}C$                                 | 3.5 | 5.3  | 8.3  | ns   |  |
|           |                 |                | 1.0 V ± 0.15 V   | $T_A = -40$ °C to +85°C                             | 2.3 |      | 9.9  |      |  |
|           |                 |                | 2511.0211        | T <sub>A</sub> = 25°C                               | 2.7 | 3.9  | 5.8  |      |  |
|           |                 |                | 2.5 V ± 0.2 V    | $T_A = -40$ °C to +85°C                             | 1.9 |      | 7    |      |  |
|           |                 |                | 221/.021/        | T <sub>A</sub> = 25°C                               | 2.4 | 3.2  | 4.7  |      |  |
|           |                 |                | 3.3 V ± 0.3 V    | $T_A = -40$ °C to +85°C                             | 1.8 |      | 5.7  |      |  |
|           |                 |                | 0.8 V            | T <sub>A</sub> = 25°C                               |     | 25.2 |      |      |  |
|           |                 |                | 1.2 V ± 0.1 V    | T <sub>A</sub> = 25°C                               | 7   | 11.3 | 18.1 |      |  |
|           |                 |                |                  | $T_A = -40$ °C to +85°C                             | 5.4 |      | 21.4 | ns   |  |
|           |                 |                | 4511.0411        | T <sub>A</sub> = 25°C                               | 5.5 | 8.1  | 12.2 |      |  |
|           |                 |                | 1.5 V ± 0.1 V    | $T_A = -40$ °C to +85°C                             | 4.1 |      | 14.5 |      |  |
| en        | ŌĒ              | Υ              | 1.8 V ± 0.15 V   | T <sub>A</sub> = 25°C                               | 4.3 | 6.5  | 10.1 |      |  |
|           |                 |                | 1.0 V ± 0.15 V   | $T_A = -40$ °C to +85°C                             | 3.3 |      | 12   |      |  |
|           |                 |                | 251/.021/        | T <sub>A</sub> = 25°C                               | 3.4 | 4.8  | 7.1  |      |  |
|           |                 |                | 2.5 V ± 0.2 V    | $T_A = -40$ °C to +85°C                             | 2.6 |      | 8.4  |      |  |
|           |                 |                | 221/ . 021/      | T <sub>A</sub> = 25°C                               | 2.9 | 4.1  | 5.9  |      |  |
|           |                 |                | 3.3 V ± 0.3 V    | $T_A = -40$ °C to +85°C                             | 2.3 |      | 6.9  |      |  |
|           |                 |                | 0.8 V            | T <sub>A</sub> = 25°C                               |     | 14   |      |      |  |
|           |                 |                | 121/.011/        | $T_A = 25^{\circ}C$                                 | 3.7 | 5.8  | 8.2  |      |  |
|           |                 |                | 1.2 V ± 0.1 V    | $T_A = -40$ °C to +85°C                             | 3.3 |      | 11   |      |  |
|           |                 |                | 15 // . 0 1 //   | T <sub>A</sub> = 25°C                               | 5.5 | 3.9  | 5.9  |      |  |
|           |                 |                | 1.5 V ± 0.1 V    | $T_A = -40$ °C to +85°C                             | 2.1 |      | 8    |      |  |
| dis       | ŌĒ              | Υ              | 4.0.1/ - 0.45.1/ | T <sub>A</sub> = 25°C                               | 3.3 | 4.5  | 6.6  | ns   |  |
|           |                 |                | 1.8 V ± 0.15 V   | $T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ | 2.9 |      | 7.4  |      |  |
|           |                 |                | 2511.0211        | T <sub>A</sub> = 25°C                               | 2.3 | 3.2  | 4.3  |      |  |
|           |                 |                | 2.5 V ± 0.2 V    | $T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ | 1.8 |      | 5.1  |      |  |
|           |                 |                | 221/ . 221/      | T <sub>A</sub> = 25°C                               | 2.4 | 4.8  | 6.2  |      |  |
|           |                 |                | 3.3 V ± 0.3 V    | $T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ | 3.1 |      | 6.7  |      |  |

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# 6.10 Switching Characteristics, $C_L = 30 pF$

over recommended operating free-air temperature range,  $C_L = 30 \text{ pF}$  (unless otherwise noted) (see Figure 2 and Figure 3)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | V <sub>cc</sub>  | T <sub>A</sub>                                      | MIN | TYP  | MAX  | UNIT |
|------------------|-----------------|----------------|------------------|---|-----|------|------|------|
|                  |                 |                | 0.8 V            | $T_A = 25^{\circ}C$                                 |     | 29   |      |      |
|                  |                 |                | 1.2 V ± 0.1 V    | $T_A = 25^{\circ}C$                                 | 7.4 | 12   | 18.7 |      |
|                  |                 |                | 1.2 V ± 0.1 V    | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$       | 6.6 |      | 21.4 |      |
|                  |                 |                | 1.5 V ± 0.1 V    | $T_A = 25^{\circ}C$                                 | 5.7 | 8.6  | 12.5 |      |
|                  |                 |                | 1.5 V ± 0.1 V    | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$       | 4.9 |      | 14.7 |      |
| t <sub>pd</sub>  | A or B          | Υ              | 1.8 V ± 0.15 V   | $T_A = 25^{\circ}C$                                 | 4.8 | 6.9  | 10.1 | ns   |
|                  |                 |                | 1.0 V ± 0.15 V   | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$       | 3.1 |      | 12   |      |
|                  |                 |                | 2511.021         | $T_A = 25^{\circ}C$                                 | 3.9 | 5.1  | 7.2  |      |
|                  |                 |                | 2.5 V ± 0.2 V    | $T_A = -40$ °C to +85°C                             | 3.3 |      | 8.7  |      |
|                  |                 |                | 227.027          | $T_A = 25^{\circ}C$                                 | 3.5 | 4.8  | 6    |      |
|                  |                 |                | 3.3 V ± 0.3 V    | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$       | 3   |      | 7    |      |
|                  |                 |                | 0.8 V            | $T_A = 25^{\circ}C$                                 |     | 33.4 |      |      |
|                  |                 |                | 1.2 V ± 0.1 V    | $T_A = 25^{\circ}C$                                 | 8.8 | 14.1 | 21.8 | ns   |
|                  |                 |                |                  | $T_A = -40$ °C to +85°C                             | 7.4 |      | 25.5 |      |
|                  |                 |                | 1.5 V ± 0.1 V    | $T_A = 25^{\circ}C$                                 | 6.9 | 10.1 | 14.6 |      |
|                  |                 |                |                  | $T_A = -40$ °C to +85°C                             | 5.6 |      | 17.4 |      |
| t <sub>en</sub>  | ŌĒ              | Υ              | 1.8 V ± 0.15 V   | $T_A = 25^{\circ}C$                                 | 5.6 | 8.1  | 12   |      |
|                  |                 |                | 1.0 V ± 0.13 V   | $T_A = -40$ °C to +85°C                             | 4.7 |      | 14.1 |      |
|                  |                 |                | 2511.0211        | T <sub>A</sub> = 25°C                               | 4.3 | 6.1  | 8.5  |      |
|                  |                 |                | 2.5 V ± 0.2 V    | $T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ | 3.8 |      | 10   |      |
|                  |                 |                | 3.3 V ± 0.3 V    | $T_A = 25^{\circ}C$                                 | 3.7 | 5.2  | 7.1  |      |
|                  |                 |                | 3.3 V ± 0.3 V    | $T_A = -40$ °C to +85°C                             | 3.4 |      | 8.3  | İ    |
|                  |                 |                | 0.8 V            | $T_A = 25^{\circ}C$                                 |     | 17.7 |      |      |
|                  |                 |                | 4.2.1/ . 0.4.1/  | $T_A = 25^{\circ}C$                                 | 5.8 | 10   | 16   |      |
|                  |                 |                | 1.2 V ± 0.1 V    | $T_A = -40$ °C to +85°C                             | 3.7 |      | 16   |      |
|                  |                 |                | 4511.0411        | $T_A = 25^{\circ}C$                                 | 5.7 | 7.7  | 10.9 |      |
|                  |                 |                | 1.5 V ± 0.1 V    | $T_A = -40$ °C to +85°C                             | 1   |      | 10.7 |      |
| t <sub>dis</sub> | ŌĒ              | Y              | 4.0.1/ . 0.45.1/ | T <sub>A</sub> = 25°C                               | 4.5 | 7.7  | 9.8  | ns   |
|                  |                 |                | 1.8 V ± 0.15 V   | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$       | 4.4 |      | 12.5 |      |
|                  |                 |                | 0.5.700.7        | T <sub>A</sub> = 25°C                               | 3.9 | 5.6  | 7.4  |      |
|                  |                 |                | 2.5 V ± 0.2 V    | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$       | 3.2 |      | 9    |      |
|                  |                 |                | 227.027          | T <sub>A</sub> = 25°C                               | 3.3 | 8.4  | 10.7 |      |
|                  |                 |                | 3.3 V ± 0.3 V    | $T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ | 6.6 |      | 10.8 |      |

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# **6.11 Operating Characteristics**

 $T_A = 25^{\circ}c$ 

|                 | PARAMETER                     |                   | TEST CONDITIONS | V <sub>cc</sub> | TYP | UNIT |  |
|-----------------|-------------------------------|-------------------|-----------------|-----------------|-----|------|--|
|                 |                               |                   |                 | 0.8 V           | 3.8 |      |  |
|                 |                               |                   |                 | 1.2 V ± 0.1 V   | 3.8 |      |  |
|                 |                               | Outpute enabled   | f = 10 MHz      | 1.5 V ± 0.1 V   | 3.7 |      |  |
|                 |                               | Outputs enabled   | I = IU IVIMZ    | 1.8 V ± 0.15 V  | 3.8 |      |  |
|                 |                               |                   |                 | 2.5 V ± 0.2 V   | 3.9 |      |  |
| 0               | Dower dissination conscitones |                   |                 | 3.3 V ± 0.3 V   | 4   | nE   |  |
| C <sub>pd</sub> | Power dissipation capacitance |                   |                 | 0.8 V           | 0   | pF   |  |
|                 |                               |                   |                 | 1.2 V ± 0.1 V   | 0   | 1    |  |
|                 |                               | Outroute disabled | f 40 MH-        | 1.5 V ± 0.1 V   | 0   | 1    |  |
|                 |                               | Outputs disabled  | f = 10 MHz      | 1.8 V ± 0.15 V  | 0   |      |  |
|                 |                               |                   |                 | 2.5 V ± 0.2 V   | 0   |      |  |
|                 |                               |                   |                 | 3.3 V ± 0.3 V   | 0   |      |  |

# 6.12 Typical Characteristics

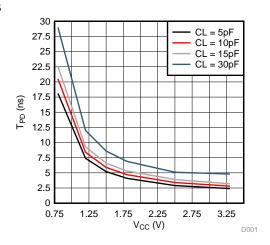


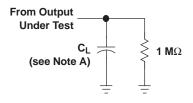
Figure 1. Propagation Delay vs. Supply Voltage and Load Capacitance

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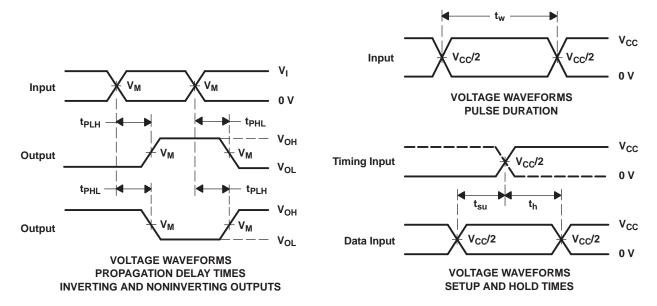


## 7 Parameter Measurement Information



**LOAD CIRCUIT** 

|                                  | V <sub>CC</sub> = 0.8 V                                   | V <sub>CC</sub> = 1.2 V<br>± 0.1 V                        | V <sub>CC</sub> = 1.5 V<br>± 0.1 V                        | $V_{CC}$ = 1.8 V $\pm$ 0.15 V                             | $V_{CC}$ = 2.5 V $\pm$ 0.2 V                              | V <sub>CC</sub> = 3.3 V<br>± 0.3 V                        |
|----------------------------------|---|---|---|---|---|---|
| C <sub>L</sub><br>V <sub>M</sub> | 5, 10, 15, 30 pF<br>V <sub>CC</sub> /2<br>V <sub>CC</sub> | 5, 10, 15, 30 pF<br>V <sub>CC</sub> /2<br>V <sub>CC</sub> | 5, 10, 15, 30 pF<br>V <sub>CC</sub> /2<br>V <sub>CC</sub> | 5, 10, 15, 30 pF<br>V <sub>CC</sub> /2<br>V <sub>CC</sub> | 5, 10, 15, 30 pF<br>V <sub>CC</sub> /2<br>V <sub>CC</sub> | 5, 10, 15, 30 pF<br>V <sub>CC</sub> /2<br>V <sub>CC</sub> |



NOTES: A.  $C_L$  includes probe and jig capacitance.

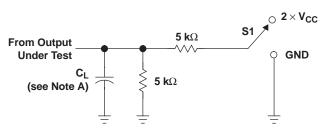
- B. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \Omega$ ,  $t_r/t_f = 3 \text{ ns}$ .
- C. The outputs are measured one at a time, with one transition per measurement.
- D.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
- E. All parameters and waveforms are not applicable to all devices.

Figure 2. Load Circuit and Voltage Waveforms

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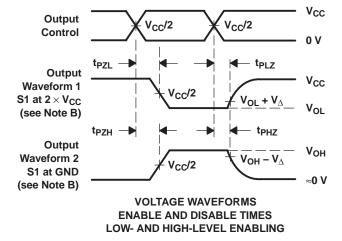
## **Parameter Measurement Information (continued)**



| TEST                               | <b>S</b> 1        |
|------------------------------------|-------------------|
| t <sub>PLZ</sub> /t <sub>PZL</sub> | 2×V <sub>CC</sub> |
| t <sub>PHZ</sub> /t <sub>PZH</sub> | GND               |

|   | $\sim$ | Α | Г |    | ın |   | ш | ıT |
|---|--------|---|---|----|----|---|---|----|
| _ | u      | А | υ | CI | ıĸ | U | J | 11 |

|                | V <sub>CC</sub> = 0.8 V | V <sub>CC</sub> = 1.2 V<br>± 0.1 V | V <sub>CC</sub> = 1.5 V<br>± 0.1 V | V <sub>CC</sub> = 1.8 V<br>± 0.15 V | $V_{CC}$ = 2.5 V $\pm$ 0.2 V | $V_{CC}$ = 3.3 V $\pm$ 0.3 V |
|----------------|-------------------------|------------------------------------|------------------------------------|-------------------------------------|------------------------------|------------------------------|
| C <sub>L</sub> | 5, 10, 15, 30 pF        | 5, 10, 15, 30 pF                   | 5, 10, 15, 30 pF                   | 5, 10, 15, 30 pF                    | 5, 10, 15, 30 pF             | 5, 10, 15, 30 pF             |
| V <sub>M</sub> | V <sub>CC</sub> /2      | V <sub>CC</sub> /2                 | V <sub>CC</sub> /2                 | V <sub>CC</sub> /2                  | V <sub>CC</sub> /2           | V <sub>CC</sub> /2           |
| V <sub>I</sub> | V <sub>CC</sub>         | V <sub>CC</sub>                    | V <sub>CC</sub>                    | V <sub>CC</sub>                     | V <sub>CC</sub>              | V <sub>CC</sub>              |
| V <sub>∆</sub> | 0.1 V                   | 0.1 V                              | 0.1 V                              | 0.15 V                              | 0.15 V                       | 0.3 V                        |



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \Omega$ ,  $t_r/t_f = 3$  ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t<sub>PLZ</sub> and t<sub>PHZ</sub> are the same as t<sub>dis</sub>.
- F. t<sub>PZL</sub> and t<sub>PZH</sub> are the same as t<sub>en</sub>.
- G. All parameters and waveforms are not applicable to all devices.

Figure 3. Load Circuit and Voltage Waveforms (Enable and Disable Times)



## 8 Detailed Description

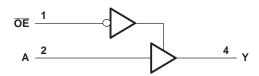
#### 8.1 Overview

The AUP family is TI's premier solution to the industry's low-power needs in battery-powered portable applications. This family of devices is specified for low static and dynamic power consumption across the entire  $V_{CC}$  range of 0.8 V to 3.6 V, resulting in an increased battery life. This product also maintains excellent signal integrity (see Figure 2 and Figure 3).

The SN74AUP1G125 device contains one buffer gate device with output enable control and performs the Boolean function Y = A. This device is fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs when the device is powered down. This inhibits current backflow into the device, which prevents damage to the device.

To assure the high-impedance state during power up or power down,  $\overline{OE}$  must be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

#### 8.2 Functional Block Diagram



#### 8.3 Feature Description

#### 8.3.1 Balanced High-Drive CMOS Push-Pull Outputs

A balanced output allows the device to sink and source similar currents. The high drive capability of this device creates fast edges into light loads so routing and load conditions should be considered to prevent ringing. Additionally, the outputs of this device are capable of driving larger currents than the device can sustain without being damaged. It is important for the power output of the device to be limited to avoid thermal runaway and damage due to over-current. The electrical and thermal limits defined the in the *Absolute Maximum Ratings* table must be followed at all times.

#### 8.3.2 Standard CMOS Inputs

Standard CMOS inputs are high impedance and are typically modelled as a resistor in parallel with the input capacitance given in the *Electrical Characteristics*,  $T_A = 25^{\circ}\text{C}$  table. The worst case resistance is calculated with the maximum input voltage, given in the *Absolute Maximum Ratings* table, and the maximum input leakage current, given in the *Electrical Characteristics*,  $T_A = 25^{\circ}\text{C}$  table, using ohm's law (R = V ÷ I).

Signals applied to the inputs need to have fast edge rates, as defined by  $\Delta t/\Delta v$  in the *Recommended Operating Conditions* table to avoid excessive currents and oscillations. If a slow or noisy input signal is required, a device with a Schmitt-trigger input should be used to condition the input signal prior to the standard CMOS input.

#### 8.3.3 Clamp Diodes

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The inputs and outputs to this device have negative clamping diodes.

#### **CAUTION**

Voltages beyond the values specified in the *Absolute Maximum Ratings* table can cause damage to the device. The input negative-voltage and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

Draduat Folder Links, CN7441104



## **Feature Description (continued)**

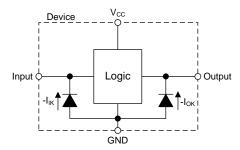


Figure 4. Electrical Placement of Clamping Diodes for Each Input and Output

#### 8.3.4 Partial Power Down (Ioff)

The inputs and outputs for this device enter a high impedance state when the supply voltage is 0 V. The maximum leakage into or out of any input or output pin on the device is specified by  $I_{off}$  in the *Electrical Characteristics*,  $T_A = 25^{\circ}C$  table.

## 8.3.5 Over-voltage Tolerant Inputs

Input signals to this device can be driven above the supply voltage so long as they remain below the maximum input voltage value specified in the *Absolute Maximum Ratings* table.

#### 8.4 Device Functional Modes

Table 1 lists the functional modes for SN74AUP1G125.

**Table 1. Function Table** 

| INP | INPUTS |      |  |  |  |  |
|-----|--------|------|--|--|--|--|
| ŌĒ  | Α      | Υ    |  |  |  |  |
| L   | Н      | Н    |  |  |  |  |
| L   | L      | L    |  |  |  |  |
| Н   | X      | Hi-Z |  |  |  |  |



# 9 Application and Implementation

#### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

#### 9.1 Application Information

The SN74AUP1G125 device is a high-drive CMOS device that is used as a output enabled buffer with a high output drive, such as an LED application. The device can produce 24 mA of drive current at 3.3 V, which is ideal for driving multiple outputs and good for high-speed applications up to 100 MHz. The inputs are 5.5-V tolerant, allowing it to translate down to  $V_{\rm CC}$ .

## 9.2 Typical Application

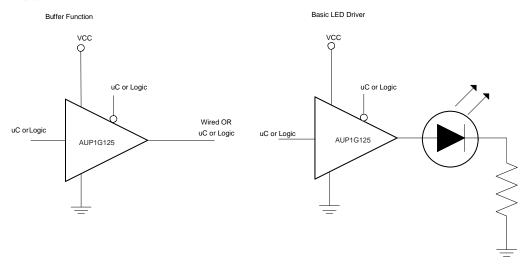


Figure 5. Application Schematic

#### 9.2.1 Design Requirements

This device uses CMOS technology and has balanced output drive. Take care to avoid bus contention because it can drive currents that would exceed maximum limits. The high drive also creates fast edges into light loads so routing and load conditions should be considered to prevent ringing.

#### 9.2.2 Detailed Design Procedure

- 1. Recommended Input Conditions
  - Rise time and fall time specs. See  $(\Delta t/\Delta V)$  in the *Recommended Operating Conditions* table.
  - Specified high and low levels. See (V<sub>IH</sub> and V<sub>IL</sub>) in the Recommended Operating Conditions table.
  - Inputs are overvoltage tolerant allowing them to go as high as (V<sub>I</sub> max) in the Recommended Operating
     Conditions table at any valid V<sub>CC</sub>.

#### 2. Recommended Output Conditions

- Load currents should not exceed (I<sub>O</sub> max) per output and should not exceed (Continuous current through V<sub>CC</sub> or GND) total current for the part. These limits are located in the *Absolute Maximum Ratings* table.
- Outputs should not be pulled above V<sub>CC</sub>.

## **Typical Application (continued)**

#### 9.2.3 Application Curve

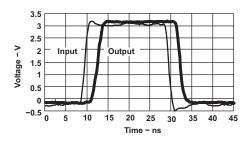


Figure 6. Switching Characteristics at 25 MHz

## 10 Power Supply Recommendations

The power supply can be any voltage between the minimum and maximum supply voltage rating located in the *Recommended Operating Conditions* table.

The VCC pin must have a good bypass capacitor to prevent power disturbance. TI recommends to use a  $0.1-\mu F$  capacitor for this device. It is ok to parallel multiple bypass caps to reject different frequencies of noise.  $0.1-\mu F$  and  $1-\mu F$  capacitors are commonly used in parallel. Install the bypass capacitor as close to the power pin as possible for best results.

## 11 Layout

## 11.1 Layout Guidelines

When using multiple bit logic devices, inputs should not float. In many cases, functions or parts of functions of digital logic devices are unused. Some examples are when only two inputs of a triple-input AND gate are used, or when only 3 of the 4-buffer gates are used. Such input pins should not be left unconnected because the undefined voltages at the outside connections result in undefined operational states.

Specified in Figure 7 are rules that must be observed under all circumstances. All unused inputs of digital logic devices must be connected to a high or low bias to prevent the inputs from floating. The logic level that should be applied to any particular unused input depends on the function of the device. The inputs should be tied to GND or  $V_{CC}$ , whichever makes more sense or is more convenient.

Even low data rate digital signals can have high frequency signal components due to fast edge rates. When a printed-circuit board (PCB) trace turns a corner at a 90° angle, a reflection can occur. A reflection occurs primarily because of the change of width of the trace. At the apex of the turn, the trace width increases to 1.414 times the width. This increase upsets the transmission-line characteristics, especially the distributed capacitance and self–inductance of the trace which results in the reflection. Not all PCB traces can be straight and therefore some traces must turn corners. Figure 8 shows progressively better techniques of rounding corners. Only the last example (BEST) maintains constant trace width and minimizes reflections.

## 11.2 Layout Example



Figure 7. Proper Multi-Gate Input Termination Diagram



# **Layout Example (continued)**

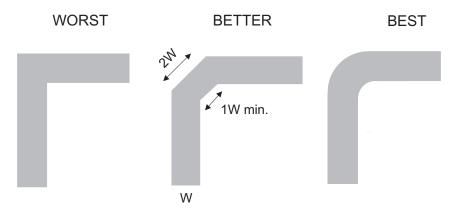


Figure 8. Trace Example



## 12 Device and Documentation Support

#### 12.1 Documentation Support

#### 12.1.1 Related Documentation

For related documentation, see the following: Implications of Slow or Floating CMOS Inputs, SCBA004

## 12.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on Alert me to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

#### 12.3 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E™ Online Community TI's Engineer-to-Engineer (E2E) Community. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

Design Support TI's Design Support Quickly find helpful E2E forums along with design support tools and contact information for technical support.

#### 12.4 Trademarks

NanoStar, E2E are trademarks of Texas Instruments. BluRay is a trademark of Blu-ray Disc Association (BDA). All other trademarks are the property of their respective owners.

### 12.5 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

#### 12.6 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

## 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.





10-Dec-2020

#### **PACKAGING INFORMATION**

| Orderable Device | Status (1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan     | Lead finish/<br>Ball material | MSL Peak Temp      | Op Temp (°C) | Device Marking<br>(4/5)  | Samples |
|------------------|------------|--------------|--------------------|------|----------------|--------------|-------------------------------|--------------------|--------------|--------------------------|---------|
| 74AUP1G125DCKRG4 | ACTIVE     | SC70         | DCK                | 5    | 3000           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -40 to 85    | HM5                      | Samples |
| SN74AUP1G125DBVR | ACTIVE     | SOT-23       | DBV                | 5    | 3000           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -40 to 85    | H25R                     | Samples |
| SN74AUP1G125DBVT | ACTIVE     | SOT-23       | DBV                | 5    | 250            | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -40 to 85    | H25R                     | Samples |
| SN74AUP1G125DCKR | ACTIVE     | SC70         | DCK                | 5    | 3000           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -40 to 85    | (HM5, HMF, HMK, HM<br>R) | Samples |
| SN74AUP1G125DCKT | ACTIVE     | SC70         | DCK                | 5    | 250            | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -40 to 85    | (HM5, HMR)               | Samples |
| SN74AUP1G125DPWR | ACTIVE     | X2SON        | DPW                | 5    | 3000           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -40 to 85    | B1                       | Samples |
| SN74AUP1G125DRLR | ACTIVE     | SOT-5X3      | DRL                | 5    | 4000           | RoHS & Green | NIPDAU   NIPDAUAG             | Level-1-260C-UNLIM | -40 to 85    | (HM7, HMR)               | Samples |
| SN74AUP1G125DRYR | ACTIVE     | SON          | DRY                | 6    | 5000           | RoHS & Green | NIPDAU   NIPDAUAG             | Level-1-260C-UNLIM | -40 to 85    | НМ                       | Samples |
| SN74AUP1G125DSFR | ACTIVE     | SON          | DSF                | 6    | 5000           | RoHS & Green | NIPDAU   NIPDAUAG             | Level-1-260C-UNLIM | -40 to 85    | НМ                       | Samples |
| SN74AUP1G125YFPR | ACTIVE     | DSBGA        | YFP                | 6    | 3000           | RoHS & Green | SNAGCU                        | Level-1-260C-UNLIM |              | HMN                      | Samples |
| SN74AUP1G125YZPR | ACTIVE     | DSBGA        | YZP                | 5    | 3000           | RoHS & Green | SNAGCU                        | Level-1-260C-UNLIM | -40 to 85    | HMN                      | Samples |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.



## PACKAGE OPTION ADDENDUM

10-Dec-2020

- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

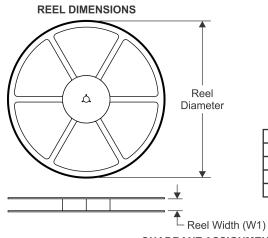
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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

PACKAGE MATERIALS INFORMATION

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## TAPE AND REEL INFORMATION





|   | Α0 | Dimension designed to accommodate the component width     |
|---|----|---|
|   | B0 | Dimension designed to accommodate the component length    |
|   | K0 | Dimension designed to accommodate the component thickness |
|   | W  | Overall width of the carrier tape                         |
| г | D1 | Pitch between successive cavity centers                   |

## QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



\*All dimensions are nominal

| Device           | Package<br>Type | Package<br>Drawing |   | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|------------------|-----------------|--------------------|---|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| 74AUP1G125DCKRG4 | SC70            | DCK                | 5 | 3000 | 178.0                    | 9.2                      | 2.4        | 2.4        | 1.22       | 4.0        | 8.0       | Q3               |
| SN74AUP1G125DBVR | SOT-23          | DBV                | 5 | 3000 | 180.0                    | 8.4                      | 3.23       | 3.17       | 1.37       | 4.0        | 8.0       | Q3               |
| SN74AUP1G125DBVT | SOT-23          | DBV                | 5 | 250  | 180.0                    | 8.4                      | 3.23       | 3.17       | 1.37       | 4.0        | 8.0       | Q3               |
| SN74AUP1G125DCKR | SC70            | DCK                | 5 | 3000 | 178.0                    | 9.2                      | 2.4        | 2.4        | 1.22       | 4.0        | 8.0       | Q3               |
| SN74AUP1G125DCKR | SC70            | DCK                | 5 | 3000 | 180.0                    | 8.4                      | 2.47       | 2.3        | 1.25       | 4.0        | 8.0       | Q3               |
| SN74AUP1G125DCKT | SC70            | DCK                | 5 | 250  | 178.0                    | 9.2                      | 2.4        | 2.4        | 1.22       | 4.0        | 8.0       | Q3               |
| SN74AUP1G125DCKT | SC70            | DCK                | 5 | 250  | 180.0                    | 8.4                      | 2.47       | 2.3        | 1.25       | 4.0        | 8.0       | Q3               |
| SN74AUP1G125DPWR | X2SON           | DPW                | 5 | 3000 | 178.0                    | 8.4                      | 0.91       | 0.91       | 0.5        | 2.0        | 8.0       | Q3               |
| SN74AUP1G125DRLR | SOT-5X3         | DRL                | 5 | 4000 | 180.0                    | 8.4                      | 1.98       | 1.78       | 0.69       | 4.0        | 8.0       | Q3               |
| SN74AUP1G125DRLR | SOT-5X3         | DRL                | 5 | 4000 | 180.0                    | 9.5                      | 1.78       | 1.78       | 0.69       | 4.0        | 8.0       | Q3               |
| SN74AUP1G125DRYR | SON             | DRY                | 6 | 5000 | 180.0                    | 9.5                      | 1.15       | 1.6        | 0.75       | 4.0        | 8.0       | Q1               |
| SN74AUP1G125DSFR | SON             | DSF                | 6 | 5000 | 180.0                    | 9.5                      | 1.16       | 1.16       | 0.5        | 4.0        | 8.0       | Q2               |
| SN74AUP1G125DSFR | SON             | DSF                | 6 | 5000 | 180.0                    | 8.4                      | 1.16       | 1.16       | 0.63       | 4.0        | 8.0       | Q2               |
| SN74AUP1G125YFPR | DSBGA           | YFP                | 6 | 3000 | 178.0                    | 9.2                      | 0.89       | 1.29       | 0.62       | 4.0        | 8.0       | Q1               |
| SN74AUP1G125YZPR | DSBGA           | YZP                | 5 | 3000 | 178.0                    | 9.2                      | 1.02       | 1.52       | 0.63       | 4.0        | 8.0       | Q1               |

**PACKAGE MATERIALS INFORMATION** 

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\*All dimensions are nominal

| Device           | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| 74AUP1G125DCKRG4 | SC70         | DCK             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| SN74AUP1G125DBVR | SOT-23       | DBV             | 5    | 3000 | 202.0       | 201.0      | 28.0        |
| SN74AUP1G125DBVT | SOT-23       | DBV             | 5    | 250  | 202.0       | 201.0      | 28.0        |
| SN74AUP1G125DCKR | SC70         | DCK             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| SN74AUP1G125DCKR | SC70         | DCK             | 5    | 3000 | 202.0       | 201.0      | 28.0        |
| SN74AUP1G125DCKT | SC70         | DCK             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| SN74AUP1G125DCKT | SC70         | DCK             | 5    | 250  | 202.0       | 201.0      | 28.0        |
| SN74AUP1G125DPWR | X2SON        | DPW             | 5    | 3000 | 205.0       | 200.0      | 33.0        |
| SN74AUP1G125DRLR | SOT-5X3      | DRL             | 5    | 4000 | 202.0       | 201.0      | 28.0        |
| SN74AUP1G125DRLR | SOT-5X3      | DRL             | 5    | 4000 | 184.0       | 184.0      | 19.0        |
| SN74AUP1G125DRYR | SON          | DRY             | 6    | 5000 | 184.0       | 184.0      | 19.0        |
| SN74AUP1G125DSFR | SON          | DSF             | 6    | 5000 | 184.0       | 184.0      | 19.0        |
| SN74AUP1G125DSFR | SON          | DSF             | 6    | 5000 | 202.0       | 201.0      | 28.0        |
| SN74AUP1G125YFPR | DSBGA        | YFP             | 6    | 3000 | 220.0       | 220.0      | 35.0        |
| SN74AUP1G125YZPR | DSBGA        | YZP             | 5    | 3000 | 220.0       | 220.0      | 35.0        |



SMALL OUTLINE TRANSISTOR



#### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
  2. This drawing is subject to change without notice.
  3. Reference JEDEC MO-178.

- 4. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.



SMALL OUTLINE TRANSISTOR



NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.

6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE TRANSISTOR



NOTES: (continued)



<sup>7.</sup> Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

<sup>8.</sup> Board assembly site may have different recommendations for stencil design.



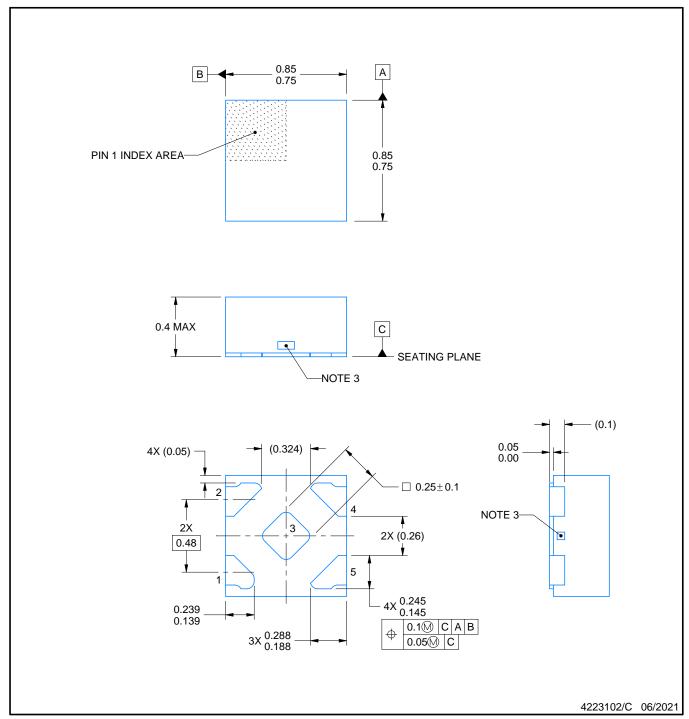
Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4211218-3/D





PLASTIC SMALL OUTLINE - NO LEAD

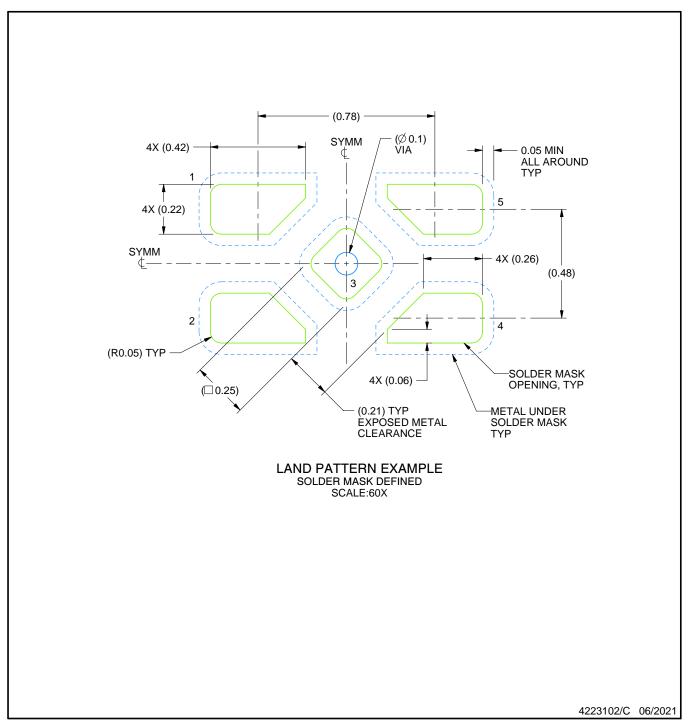


#### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. The size and shape of this feature may vary.



PLASTIC SMALL OUTLINE - NO LEAD

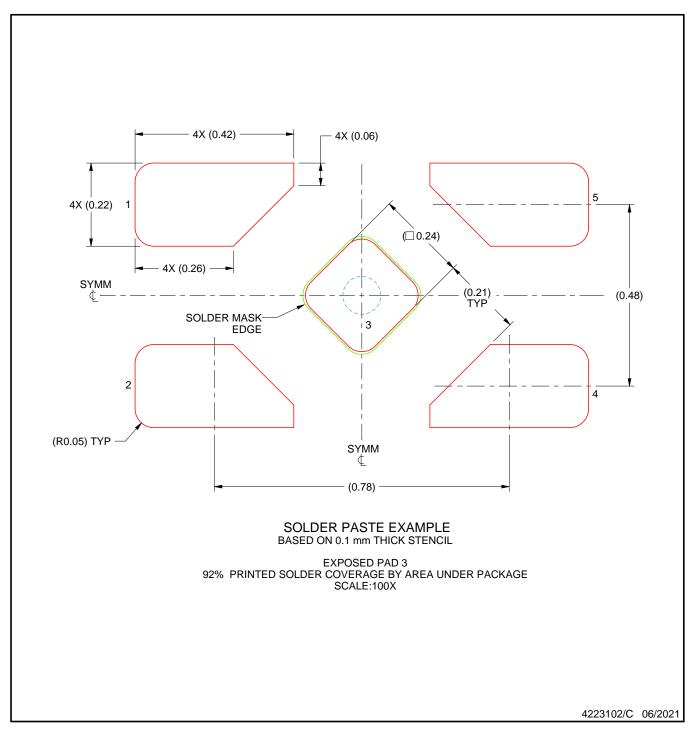


NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, refer to QFN/SON PCB application note in literature No. SLUA271 (www.ti.com/lit/slua271).



PLASTIC SMALL OUTLINE - NO LEAD



NOTES: (continued)

5. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.







## NOTES:

- All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.





NOTES: (continued)

3. Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints. For more information, see Texas Instruments literature number SNVA009 (www.ti.com/lit/snva009).



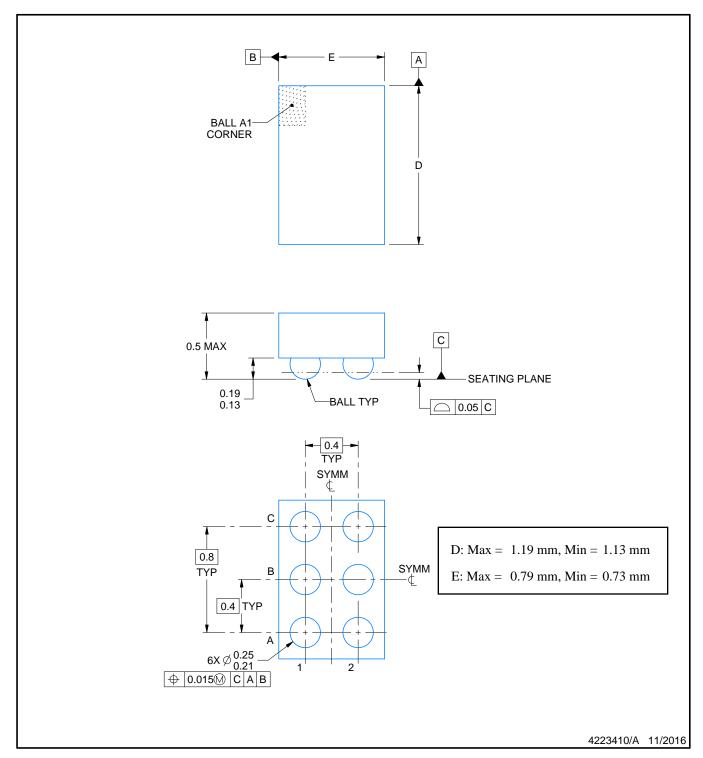


NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.



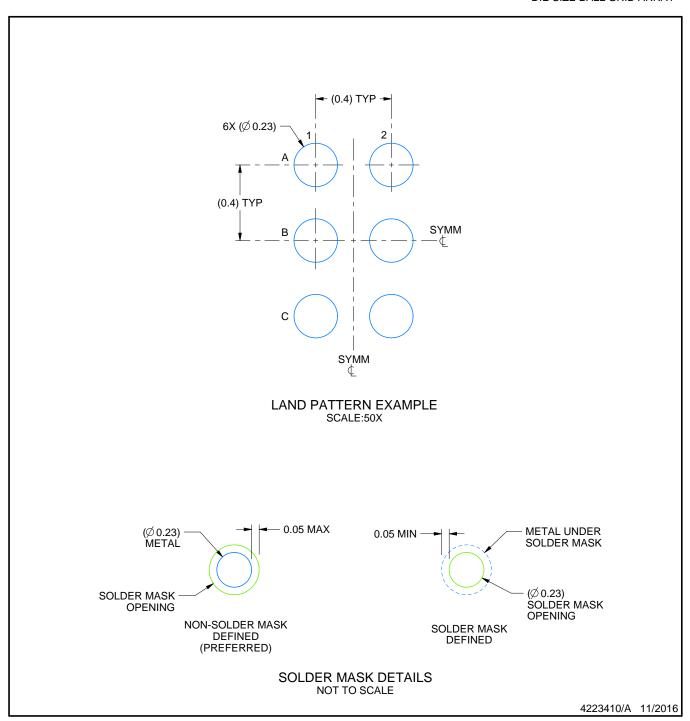




## NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
  2. This drawing is subject to change without notice.



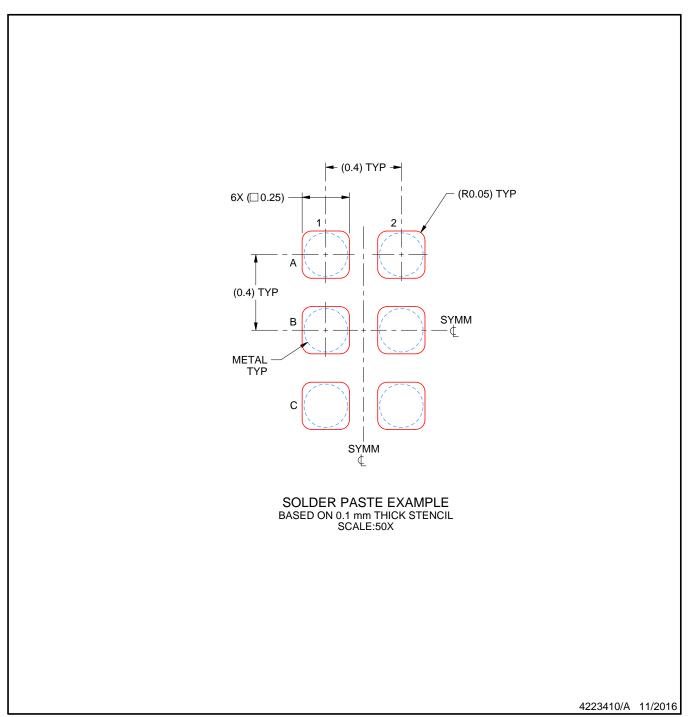


NOTES: (continued)

3. Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints. For more information, see Texas Instruments literature number SNVA009 (www.ti.com/lit/snva009).



DIE SIZE BALL GRID ARRAY



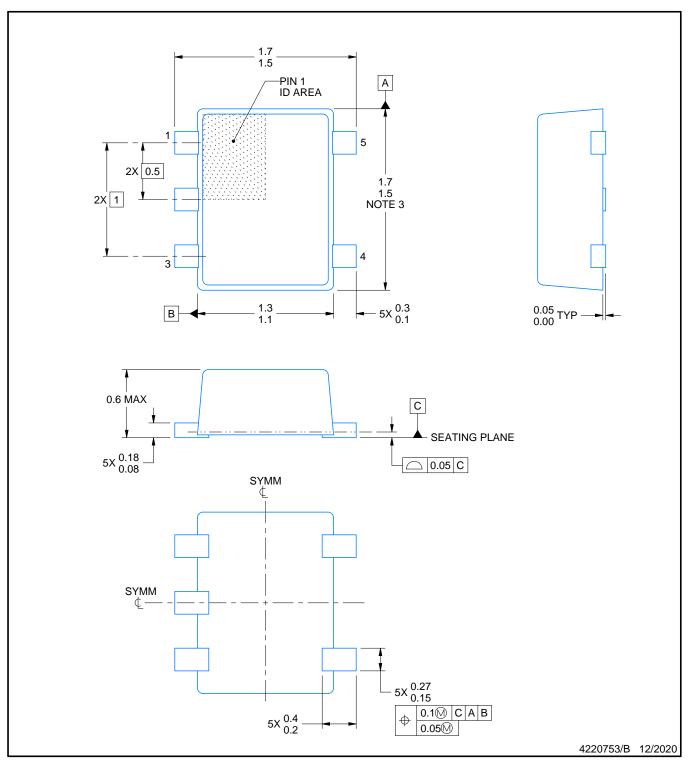
NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.





PLASTIC SMALL OUTLINE



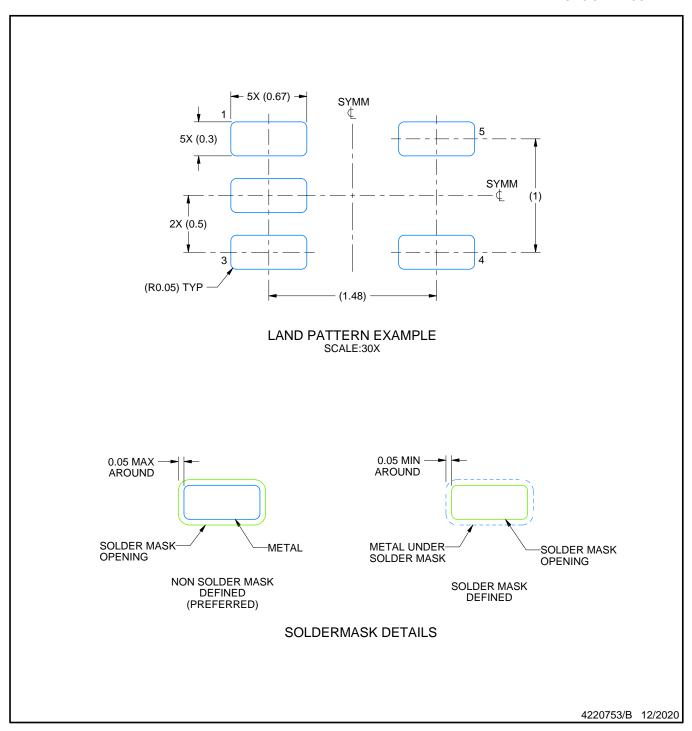
- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
  4. Reference JEDEC registration MO-293 Variation UAAD-1



PLASTIC SMALL OUTLINE

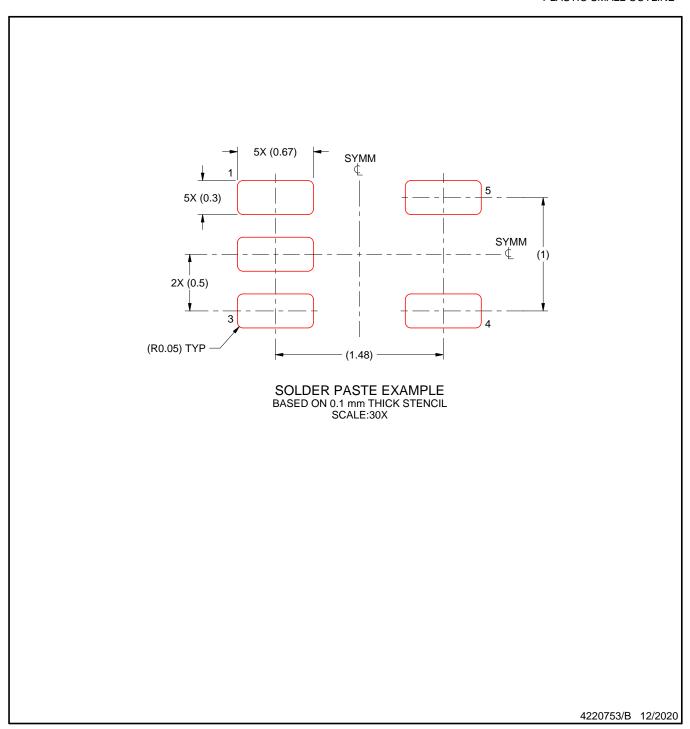


NOTES: (continued)

- 5. Publication IPC-7351 may have alternate designs.
- 6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



PLASTIC SMALL OUTLINE



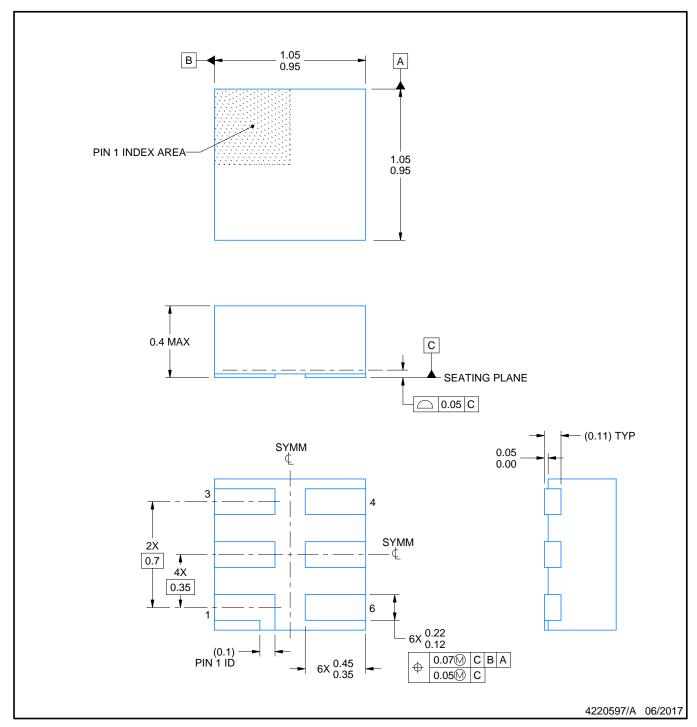
NOTES: (continued)



<sup>7.</sup> Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

<sup>8.</sup> Board assembly site may have different recommendations for stencil design.



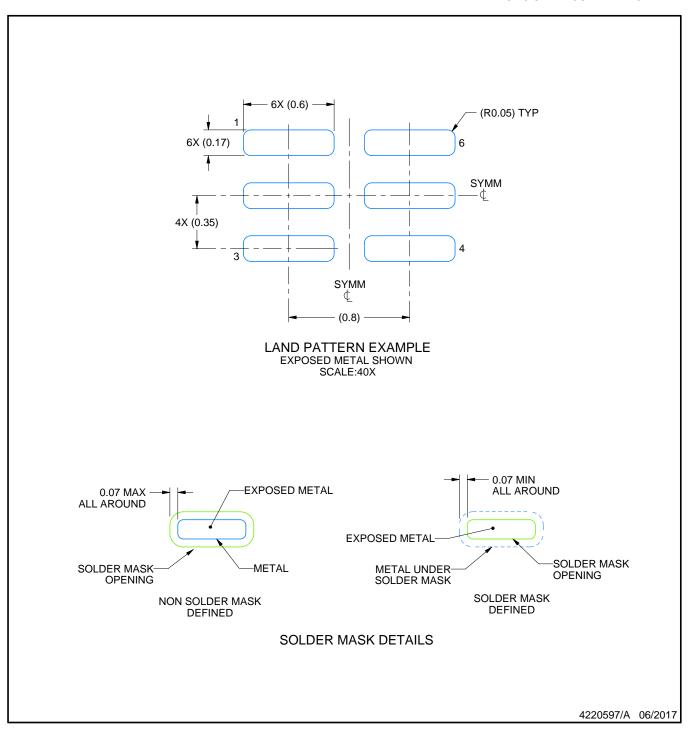


- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. Reference JEDEC registration MO-287, variation X2AAF.

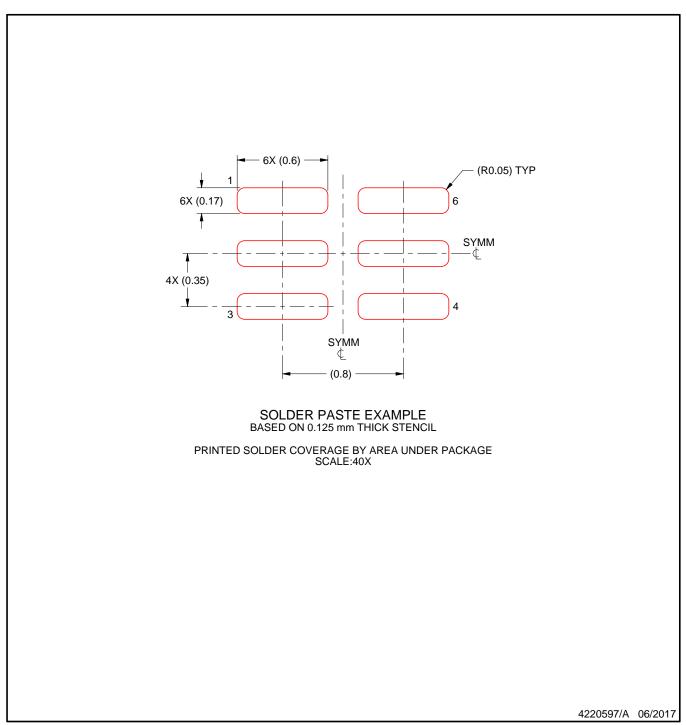




NOTES: (continued)

4. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).





4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



# DCK (R-PDSO-G5)

# PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
- D. Falls within JEDEC MO-203 variation AA.



# DCK (R-PDSO-G5)

## PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
- D. Publication IPC-7351 is recommended for alternate designs.
- E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.





Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4207181/G



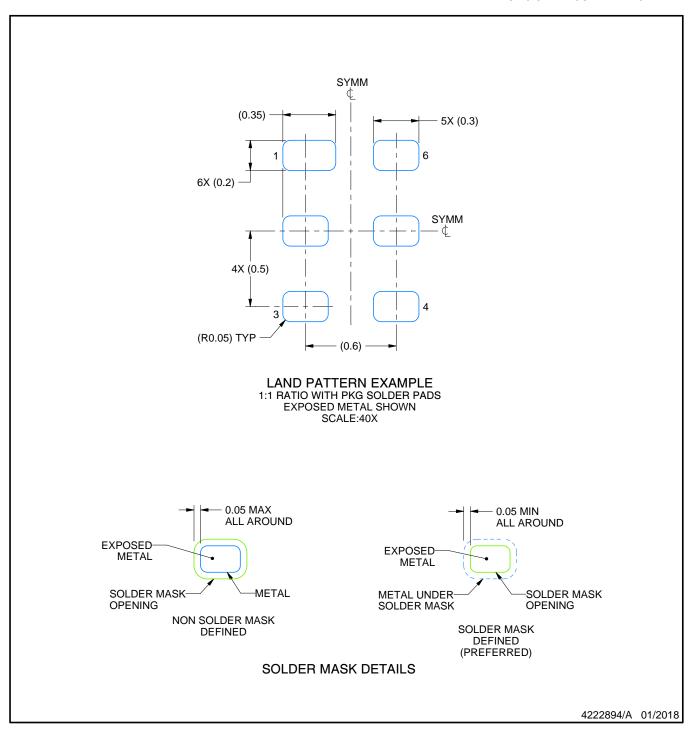




- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.





NOTES: (continued)

3. For more information, see QFN/SON PCB application report in literature No. SLUA271 (www.ti.com/lit/slua271).





NOTES: (continued)

Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



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